

External Laser Source Interconnect System (ELSIS) >

The External Laser Source Interconnect System (ELSIS) is a first-to-market blind-mating optical and electrical interconnect in a pluggable module format that supports co-packaged optics (CPO) requiring a remote laser source.

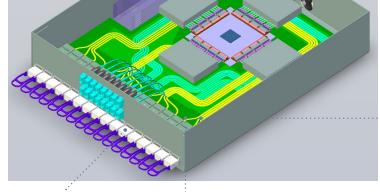


External Laser Source Interconnect System
(FLSIS)

FEATURES AND ADVANTAGES

CPO implementation

Brings optical fibers directly to the IC substrate or package, eliminating the need for traditional highspeed electrical interfaces. Optical signals are direct to the external network, saving power by eliminating high-speed electrical I/O drivers on the IC and in pluggable modules while increasing front-panel I/O density.



ELS pluggable module

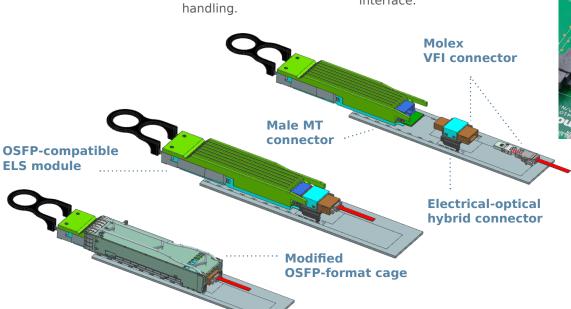
Houses high-power continuous wave lasers, which provide optical power to CPO tiles. Simplifies optical eye safety and cabling issues during mating and handling.

OSFP-format cage

Provides known electrical, thermal and mechanical characteristics with an industry-standard interface.

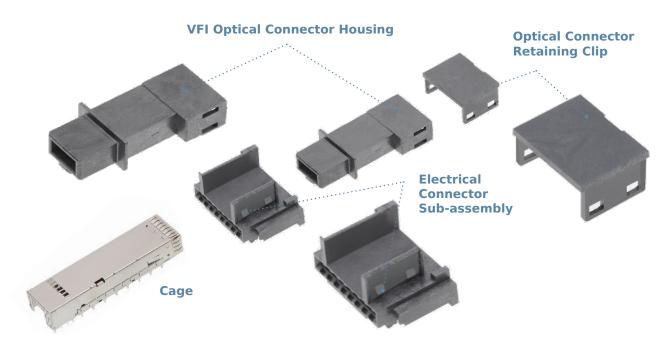
VFI optical connector interface

Delivers superior optical performance with any MTferrule-based footprint. Meets high-density requirements with 8-, 12-, 24and 32-fiber MT ferrules





External Laser Source Interconnect System (ELSIS) >



MARKETS AND APPLICATIONS

Telecommunications/Networking

Switches

Data/Computing

Machine Learning Systems
High-Performance Computing Systems

SPECIFICATIONS

Reference Information

Packaging: Dependent on component: Individual pack, tape and reel, or tray. UL File No.: Utilizes 94V0 materials

Mates With: VFI Daughter Card Connector and

VFI Backplane Adapter
Use With: MT Ferrule
Designed In: Millimeters

RoHS: Yes

Optical

IL: Ferrule dependent
RL: Ferrule type dependent
Mate/Demate (min.): 50 cycles

Mechanical

MT Spring Force: 10N per ferrule

Physical

Housing: Polymer

Ferrules: MT: Glassed-filled PPS Operating Temperature: -20 to +70°C

www.molex.com/link/elsis.html